

Service Information

Already published Service Informations:

CHANGES DURING PRODUCTION

* During production a new Tape board & Combi board are introduced to meet new GSM requirement.

The main difference in these new boards are:

- addition of 2nd copper layer (double sided pc board) as shielding
- addition of a capacitor on each board.

Combi board:

Add 2611 4822 122 33848 47pF 5% 50V

Tape board:

Add 2771 4822 122 33848 47pF 5% 50V

The new boards can be recognized by printing mark:

- a) 3139_113_34661_01 for the Combi board (all parts)
- b) 3139_113_34951_01 for the Tape board

The affected portion of the circuits & layouts are given on the next page.

